

• General Description

It combines advanced trench MOSFET technology with a low resistance package to provide extremely low

$R_{DS(ON)}$ .

• Features

- AEC-Q101 Qualified
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

• Application

- BLDC Motor driver
- DC-DC
- Battery protection

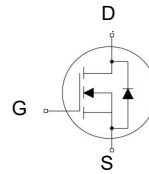
• Ordering Information:

Part NO.	ZMSA015N08HR
Marking	ZMS015N08H
Packing Information	REEL TAPE
Basic ordering unit (pcs)	2000

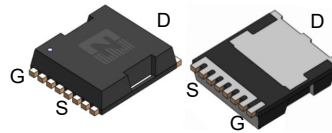
• Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Value	Unit
Drain-Source Voltage	$V_{DS}$		80	V
Gate-Source Voltage <sup>①</sup>	$V_{GS}$		$\pm 20$	V
Continuous Drain Current	$I_D$	$T_C=25^\circ\text{C}$	240	A
	$I_D$	$T_C=75^\circ\text{C}$	194	A
	$I_D$	$T_C=100^\circ\text{C}$	168	A
Pulsed Drain Current	$I_{DM}$	Pulsed; $t_p \leq 10 \mu\text{s}$ ; $T_{mb} = 25^\circ\text{C}$ ;	720	A
Total Power Dissipation	$P_D$	$T_C=25^\circ\text{C}$	250	W
Total Power Dissipation	$P_D$	$T_A=25^\circ\text{C}$	5.0	W
Operating Junction Temperature	$T_J$		-55 to +175	$^\circ\text{C}$
Storage Temperature	$T_{STG}$		-55 to +175	$^\circ\text{C}$
Single Pulse Avalanche Energy	$E_{AS}$	$L=0.1\text{mH}$ , $V_{GS}=10\text{V}$ , $R_g=25\Omega$ ,	310	mJ
		$L=0.5\text{mH}$ , $V_{GS}=10\text{V}$ , $R_g=25\Omega$ ,	713	mJ
ESD Level (HBM)	CLASS 2			

• Product Summary



$V_{DS} = 80\text{V}$   
 $R_{DS(ON)} = 1.6\text{m}\Omega$   
 $I_D = 240\text{A}$



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**•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	$R_{thJC}$		-	0.6	$^{\circ}C/W$
Thermal resistance, junction-ambient	$R_{thJA}^{\textcircled{2}}$		-	30	$^{\circ}C/W$
Soldering temperature	$T_{sold}$		-	260	$^{\circ}C$

**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	80			V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2.0	3.3	4.0	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{GS}=0V, V_{DS}=80V$			1.0	$\mu A$
Gate- Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$			100	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=30A$		1.6	2.1	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS}=5V, I_{SD}=20A$		28		S
Diode Forward Voltage	$V_{FSD}$	$V_{GS}=0V, I_{SD}=30A$			1.3	V

**•Dynamic characteristics**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input capacitance	$C_{iss}$	$f=1MHz, V_{DS}=25V$	-	9130	-	pF
Output capacitance	$C_{oss}$		-	6640	-	
Reverse transfer capacitance	$C_{rss}$		-	117	-	
Gate Resistance	$R_g$	$f=1MHz$	-	2.5		$\Omega$
Total gate charge	$Q_g$	$V_{DD}=15V, I_D=20A, V_{GS}=10V$	-	121	-	nC
Gate - Source charge	$Q_{gs}$		-	24	-	
Gate - Drain charge	$Q_{gd}$		-	23	-	
Turn-ON Delay time	$t_{D(on)}$	$V_{GS}=10V, V_{DS}=15V, R_G=3.3\Omega, I_D=20A$	-	19	-	ns
Turn-ON Rise time	$t_r$		-	14	-	ns
Turn-Off Delay time	$t_{D(off)}$		-	31	-	ns
Turn-Off Fall time	$t_f$		-	37	-	ns
Reverse Recovery Time	$t_{RR}$	$V_{DD}=20V, di_S/dt=100A/\mu s, I_S=50A$	-	76	-	ns
Reverse Recovery Charge	$Q_{RR}$		-	120	-	nC

Fig.1 Gate-Charge Characteristics

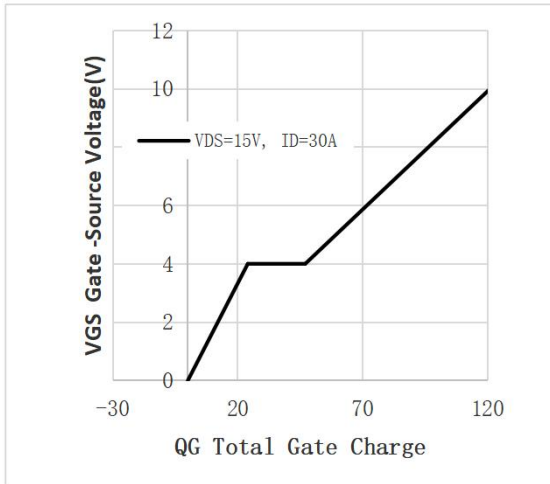


Fig.2 Capacitance Characteristics

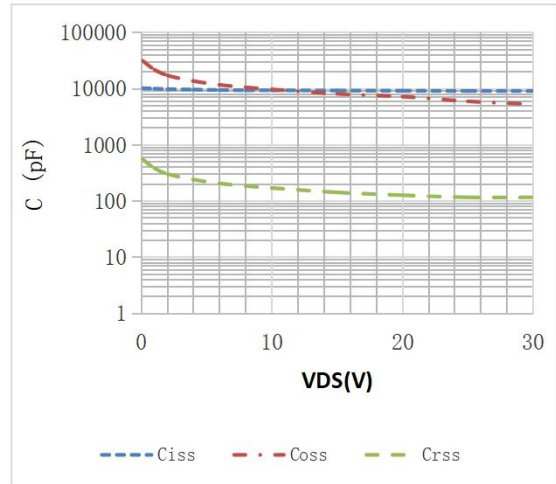


Fig.3 Power Dissipation

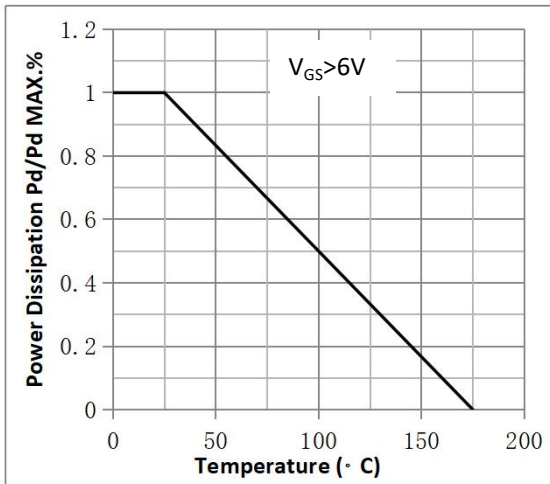


Fig.4 Typical output Characteristics

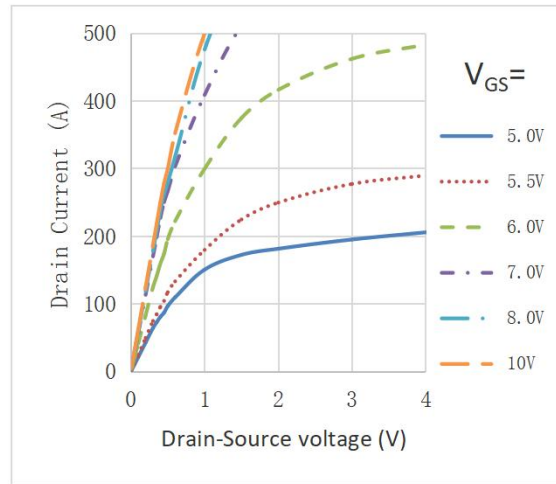


Fig.5 Threshold Voltage V.S Junction Temperature

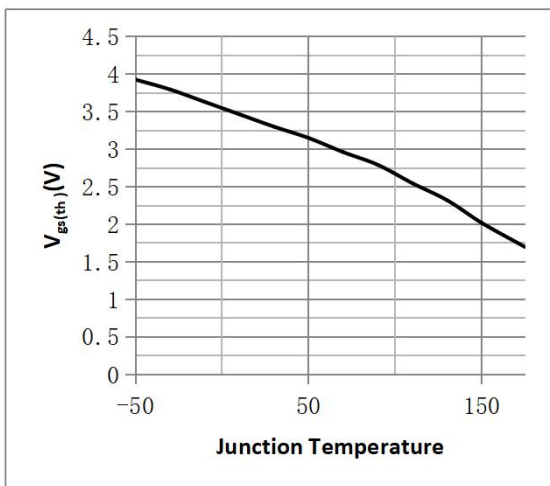


Fig.6 Resistance V.S Drain Current

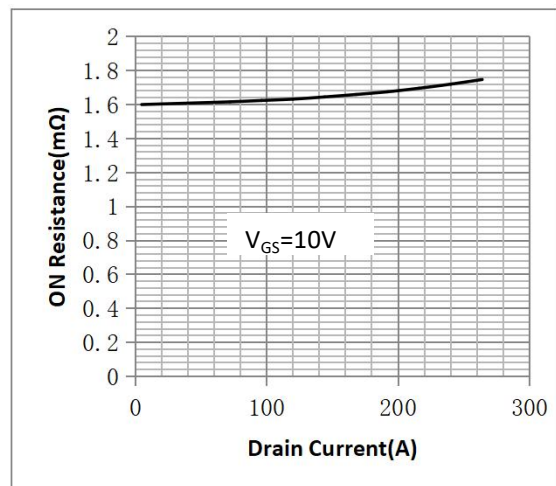


Fig.7 On-Resistance VS Gate Source Voltage

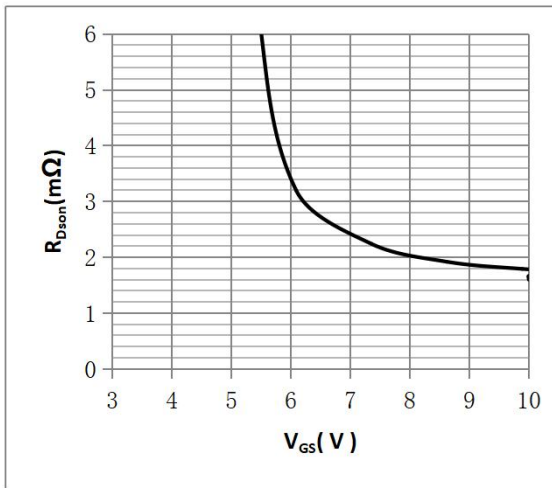


Fig.8 On-Resistance V.S Junction Temperature

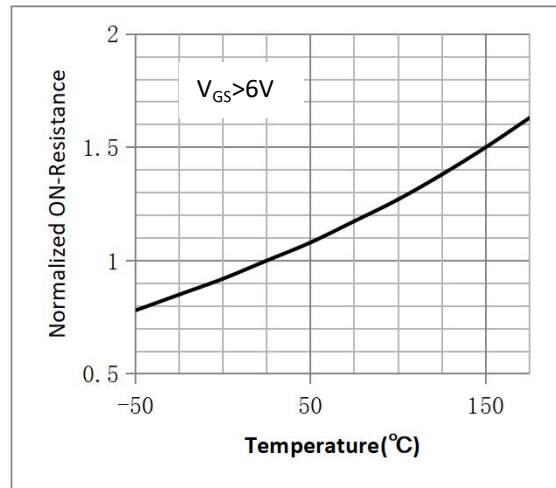


Figure 9. Diode Forward Voltage vs. Current

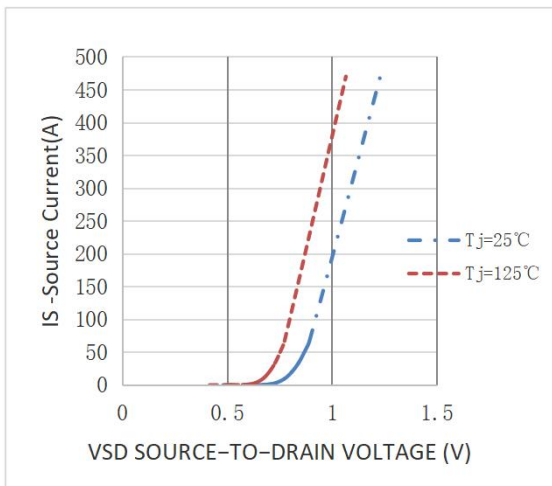


Figure 10. Transfer Characteristics

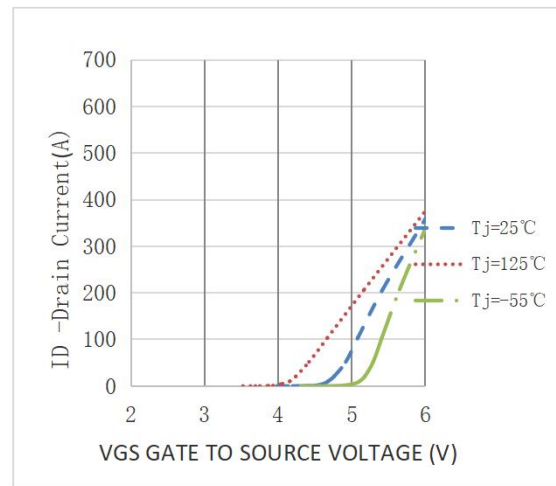


Fig.11 Safe Operating Area

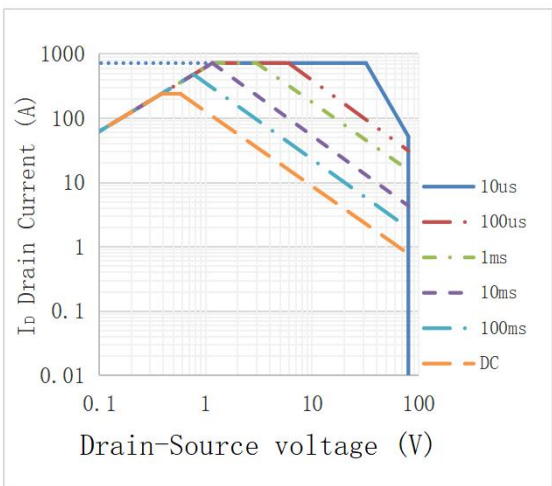
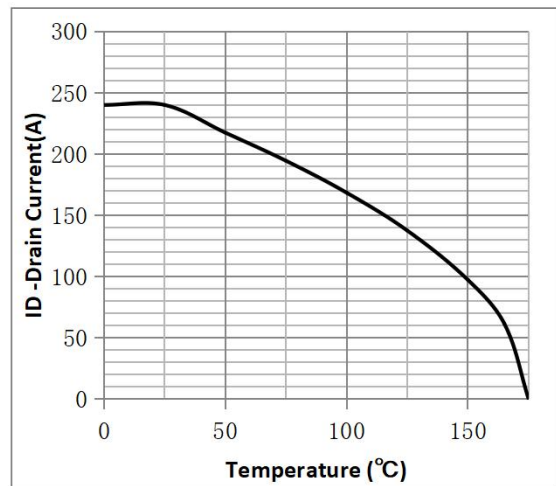
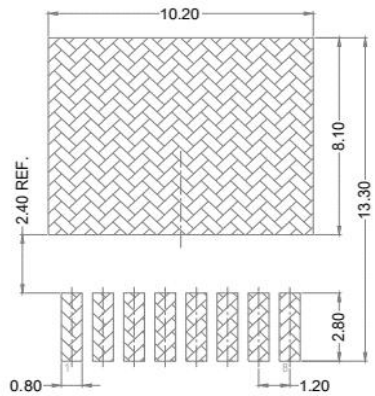
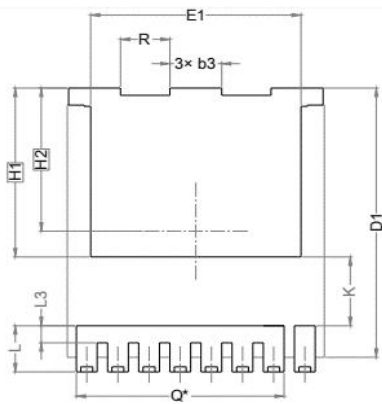
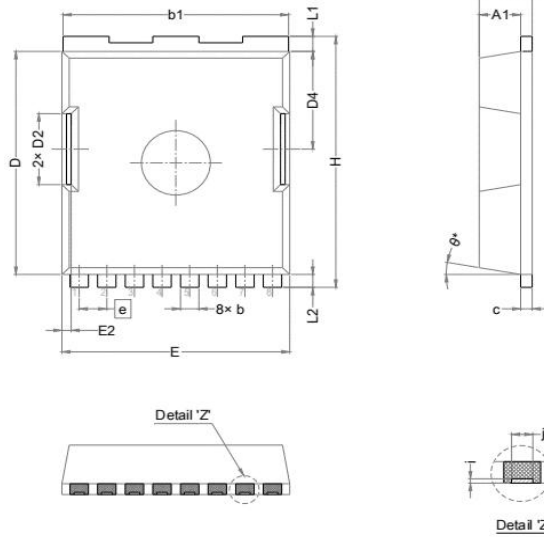


Fig.12 ID vs. Case Temperature<sup>③</sup>



•TOLL Package Outline



SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	2.20	2.30	2.40
A1	1.70	1.80	1.90
b	0.70	0.80	0.90
b1	9.70	9.80	9.90
b3	1.90	2.00	2.10
c	0.40	0.50	0.60
D	10.28	10.38	10.48
D1	10.98	11.08	11.18
D2	3.20	3.30	3.40
D4	4.45	4.55	4.65
E	9.80	9.90	10.00
E1	8.00	8.10	8.20
E2	0.30	0.40	0.50
e	1.20 BSC		
H	11.58	11.68	11.78
H1	6.95 BSC		
H2	5.89 BSC		
i	0.10 REF.		
j	0.46 REF.		
K	2.80 REF.		
L	1.60	1.90	2.10
L1	0.60	0.70	0.80
L2	0.50	0.60	0.70
L3	0.60	0.70	0.80
N	8		
Q	6.80 REF.		
R	1.80	1.90	2.00
θ	10° REF.		

**Note:**

- ① Pulse :  $V_{GS}=+20V/-20V$ , Duty cycle=50%,  $T_j=175^{\circ}C$ ,  $t=1000$  hours; For DC , the following test conditions can be passed:  $V_{GS}=+20V/-10V$ ,  $T_j=175^{\circ}C$ ,  $t=1000$  hours;
- ② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;
- ③ Practically the current will be limited by PCB, thermal design and operating temperature.  $V_{GS}=10V$ .

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Revision History

Version	Date	Change
A	2021.9.6	
B	2022.9.5	1.Add Reach, HF figure, 2.ID modify